# CRMQTL0317A

#### N-Channel 30V, 13.7mΩ Typ. Power MOSFET

# **Description**

#### **Features**

• 30V, 16A

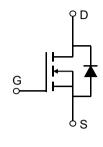
$$R_{DS(ON)}$$
 Typ = 13.7m $\Omega$  @  $V_{GS}$  = 10 $V$ 

$$R_{DS(ON)}$$
 Typ = 23m $\Omega$  @  $V_{GS}$  = 4.5V

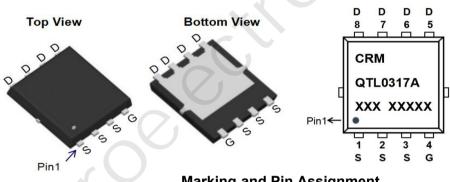
- Advanced Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- Lead Free
- 100% UIS TESTED!
- 100% ΔVds TESTED!

# **Application**

- Load Switch
- PWM Application
- Power Management







**Marking and Pin Assignment** 

# **Package Marking and Ordering Information**

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMQTL0317A	CRMQTL0317A	PDFN3.3x3.3-8L	TAPING	13"	5000	50000

#### Absolute Maximum Ratings (@ T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
$V_{DS}$	Drain-to-Source Voltage		30	V
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T <sub>C</sub> = 25°C	16	А
I <sub>D</sub>	Continuous Diain Current	T <sub>C</sub> = 100°C	9.6	А
I <sub>DM</sub>	Pulsed Drain Current (1)		64	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (2)		12	mJ
$P_{D}$	Power Dissipation	T <sub>C</sub> = 25°C	7.4	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		17	°C/W
$T_J,T_STG$	Junction & Storage Temperature Range		-55 to 150	°C



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# **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$	-	-	1.0	μА
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	1	1.5	2	V
D	Static Drain-Source ON-Resistance <sup>(3)</sup>	$V_{GS} = 10V, I_D = 2.9A$	2.9A - 13.7 17.8	mΩ		
$R_{DS(ON)}$	Static Drain-Source ON-Resistance	$V_{GS} = 4.5V, I_D = 2A$	-	23	29.9	mΩ
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance		-(	510	-	pF
$C_{oss}$	Output Capacitance	$V_{GS} = 0V, V_{DS} = 15V,$ f = 1MHz	X -	61	-	pF
$C_{rss}$	Reverse Transfer Capacitance	7 - 1141112		51	-	pF
$Q_g$	Total Gate Charge		<u></u> -	10	-	nC
$Q_gs$	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 15V, I_{D} = 3A$	-	2	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	V <sub>DS</sub> 10V, I <sub>D</sub> 0/V	-	2	-	nC
Switchin	g Characteristics					
$t_{\text{d(on)}}$	Turn-On DelayTime	, (U	-	4	-	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 15V$	-	6	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 3A$ , $R_{GEN} = 3\Omega$	-	12	-	ns
$t_f$	Turn-Off Fall Time		-	3	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I <sub>S</sub>	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	16	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	64	Α
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0V$ , $I_{S} = 2.9A$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	8	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 3A$ , di/dt = 100A/us	-	2	_	nC

Notes:

<sup>1.</sup> Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

<sup>2.</sup>  $E_{AS}$  condition: Starting  $T_J$ =25°C,  $V_{DD}$ =15V,  $V_G$ =10V,  $R_G$ =25ohm, L=0.5mH,  $I_{AS}$ =7A

<sup>3.</sup> Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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# **Test Circuit**

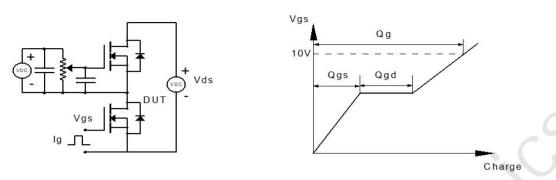


Figure 1: Gate Charge Test Circuit & Waveform

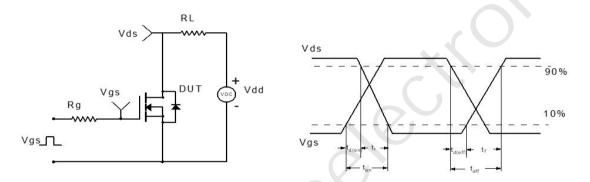


Figure 2: Resistive Switching Test Circuit & Waveform

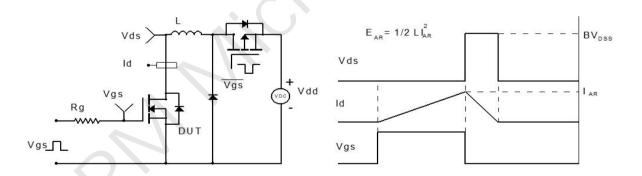


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

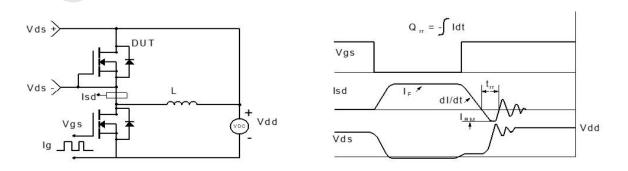
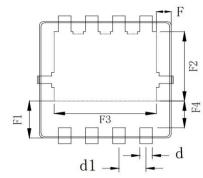


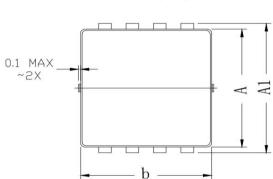
Figure 4: Diode Recovery Test Circuit & Waveform

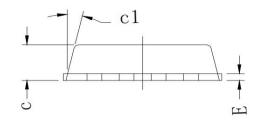
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# Package Mechanical Data(PDFN3.3x3.3-8L)







	COMMON DIMI	ENSION (MM)	
PKG		PDFN 3.3×3.3-8	4
SYMBOL	MIN	TYP	MAX
Α	3. 070	3.100	3.130
A1	3. 300	3.400	3.500
b	3. 070	3, 100	3.130
С	0.770	0.800	0.830
c1	-	13°	N-L
d	0. 275	0.300	0. 325
d1	0. 625	0.650	0.675
E	0. 144	0. 152	0. 160
F	0. 300	0. 325	0.350
F1	0. 960	0. 985	1.010
F2	1. 775	1. 800	1.825
F3	2. 425	2. 450	2. 475
F4	0.660	0.685	0.710

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# **Contact information**

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